

Controlling smoothness of thin platinum ALD films

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Outline



- □ Motivation: X-Ray Diffraction Gratings
 - Improvement in grating performance
- □ Making the Pt thinner
 - Methods:
 - Deposition
 - Metrology
 - Data
- □ Summary

Soft X-Rays

Ultratech CNT

- Important questions in cosmology are addressed by analysis of the soft x-ray spectrum
 - Role of Active Galactic Nuclei in galaxy formation
 - Characterization of the Warm-Hot Intergalactic Medium and the missing baryon problem



Critical Angle Transmission Grating **Ultratech CNT**



Grating equation:

 $m \lambda = p (\sin(\theta) + \sin(\beta_m)),$ m = diffraction order

Blazing: $\beta_m \sim \theta$

High reflectivity: $\theta < \theta_c$ = critical angle of total external reflection

Strawman: Silicon grating, $\theta = 1.5^{\circ}$ p = 200 nmb = 40 nm

aspect ratio d/b = 150

Total external reflection $\theta <$ θ_{c}

 $\theta_{c} \uparrow \Rightarrow \theta \uparrow$

- m \uparrow (higher order peaks i.e. greater resolving power)
- Higher energy

 θ_{c} depends on (material, λ)

- $\theta_c \simeq 1.7^\circ$ for (Si,1nm)
- $\theta_c \simeq 2.4^\circ$ for (Pt,1nm)

Case for Pt ALD: increase θ_c by conformally coating Si grating with Pt

Manufacturing CAT Grating





ALD Pt Coated CAT Grating





Higher order diffraction peaks => greater resolving power Access to higher energy (shorter wavelength)

Goal

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Deposition:

Experimental

- Savannah 200 (200mm dia reactor)
- 2" substrates of Si and Si-TOX at reactor center
- 120sec UV-O3 pre-clean
- Me₃PtCpMe+O2 (270°C), Me3PtCpMe
 +O3 (150°C)
- Ozone 120mg/liter
- Measurement:
 - Ellipsometry thickness
 - 4-point probe resistivity/macroscopic continuity
 - XRR thickness, density, roughness
 - AFM roughness







Ellipsometry Validation





- Good quality fit over wide spectral range (1.4-5.9eV)
- Fit parameters tightly bound
- Correlation between optical parameters and thickness is low
- Thickness from ellipsometry is about 4-6Å more than XRR





d:150 min

Physical considerations

- Energetics:
 - Does Pt deposit on previously deposited Pt or on substrate?
 - Does deposited Pt tend to agglomerate into Pt particles vs remain as a film?

C: 90 min

- •Kinetics:
 - What is rate of surface diffusion/ agglomeration?
 - How does it compare to rate of deposition?

0:60 min

In-situ TEM at **650°C**, 10mbar "air"







Routes to smoother, thinner films **Ultratech CNT**



"Standard" (270°C, O₂ process) **Ultratech CNT**



Thickness increases linearly with number of cycles Resistivity increases super-exponentially \rightarrow percolation?

Percolation





Ozone at 150°C





- O₃ film is continuous at lower thicknesses
- No sign of percolation threshold
- However, ~ 80Å resistivity suggests film quality is poorer
 - Xray Reflectivity is low
 - Residual carbon?

Ozone dose





- Increasing O₃ dose by 4X gives lowest resistivity
- Resistivity improvement is not as much for thicker film

Buffer Layer (Al₂O₃ vs ZrO₂)





□ At 80cycles:

- Resistivity on ZrO2 is ~ 35% lower with 10Å thinner film
- □ At 145 cycles
 - Resistivity is similar for both surfaces

ZrO₂ surface encourages faster nucleation and continuity

Thickness of Al₂O₃ layer





Pt nucleation enhancement on Al2O3 maintained to 3 cycles of Al2O3



- Improvement in "device" performance increase in critical angle for X-Ray CAT grating
- Percolation threshold reduced from ~ 5nm to less than 4nm for ozone process.
 - Film quality improvement required

□ Thin (3cycles) Al2O3 is adequate for improved Pt coalasence